



PRODUCT CHANGE NOTIFICATION

PCN#: PCM-0745

PCN Date: 3 February, 2006

Product Families Affected

Crystals: ATP-SM Series

Reason For Change

In an effort to make CTS product environmentally friendly and compliant to the EU Directive No. 2002/95/EC, CTS is changing the product families listed above to meet the material declaration requirements of Joint Industry Guidelines (JIG) defined in controlling document JIG-101.

Description For Change

The manufacturing process for the above product families is changing from a tin/lead (Sn/Pb) lead finish to a tin/zinc/copper (Sn/Zn/Cu) lead finish.

The SnZnCu lead finish is capable of 260°C solder reflow processing and is backward compatible to traditional SnPb solder reflow profiles.

Implementation

Implementation dates for this product family is date code 0601. The following web links will take you to selector guides that provide additional links to product specific change schedules and other RoHS information.

<http://www.ctscorp.com/components/xtal.asp>